



# US2A-US2M

## Surface Mount Ultra Fast Rectifiers

### Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junctions
- Ultrafast reverse recovery time
- Low switching losses, high efficiency
- High forward surge capability
- High temperature soldering:  
260°C/10 seconds at terminals
- Component in accordance to  
RoHS 2002/95/1 and WEEE 2002/96/EC



SMB (DO - 214AA)

### Mechanical Date

- **Case:** JEDEC DO-214AA molded plastic body over glass passivated chip
- **Terminals:** Solder plated, solderable per J-STD-002B and JESD22-B102D
- **Polarity:** Laser band denotes cathode end

### Major Ratings and Characteristics

$I_{F(AV)}$	2.0 A
$V_{RRM}$	50 V to 1000 V
$I_{FSM}$	50 A
$t_{rr}$	50 nS , 75 nS
$V_F$	1.0 V , 1.3 V , 1.7 V
$T_j \text{ max.}$	150 °C

### Maximum Ratings & Thermal Characteristics

( $T_A = 25\text{ °C}$  unless otherwise noted)

Items	Symbol	US2A	US2B	US2D	US2G	US2J	US2K	US2M	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	$I_{F(AV)}$	2.0							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	50							A
Thermal resistance from junction to lead <sup>(1)</sup>	$R_{\theta JL}$	25							°C/ W
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +150							°C

Note 1: Mounted on P.C.B. with 0.28 x 0.28" (7.0 x 7.0mm) copper pad areas.

### Electrical Characteristics ( $T_A = 25\text{ °C}$ unless otherwise noted)

Items	Test conditions	Symbol	US2A~US2D	US2G	US2J~US2M	UNIT
Instantaneous forward voltage	$I_F = 2.0\text{ A}^{(2)}$	$V_F$	1.0	1.3	1.7	V
Reverse current	$V_R = V_{DC}$	$I_R$	$T_A = 25\text{ °C}$			μA
			$T_A = 100\text{ °C}$			
Reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$	$t_{rr}$	50		75	nS
Typical junction capacitance	4.0 V , 1MHz	$C_J$	15			pF

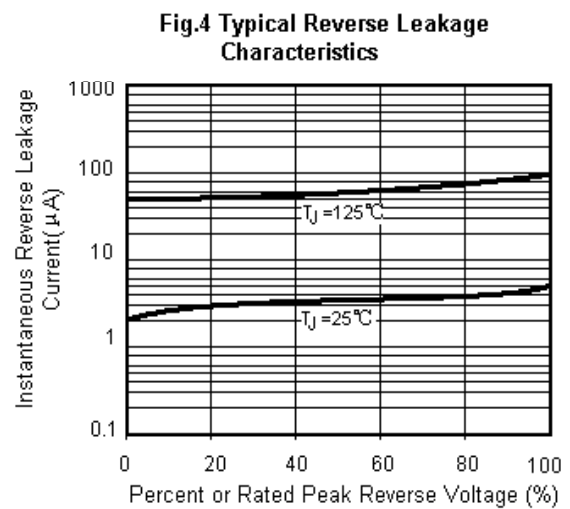
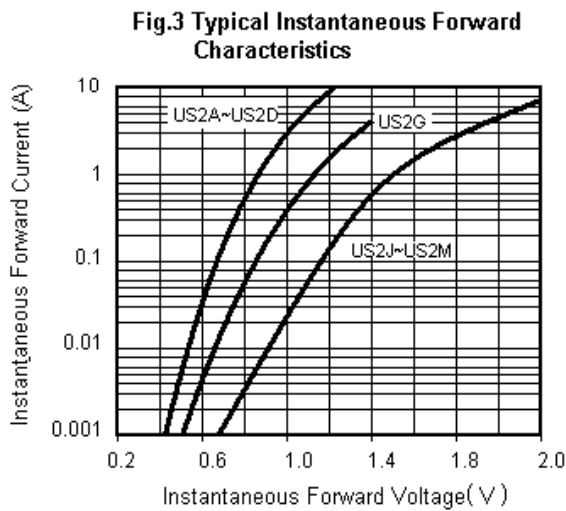
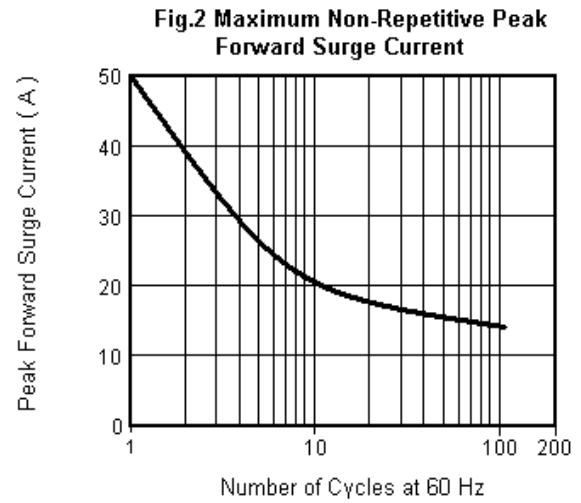
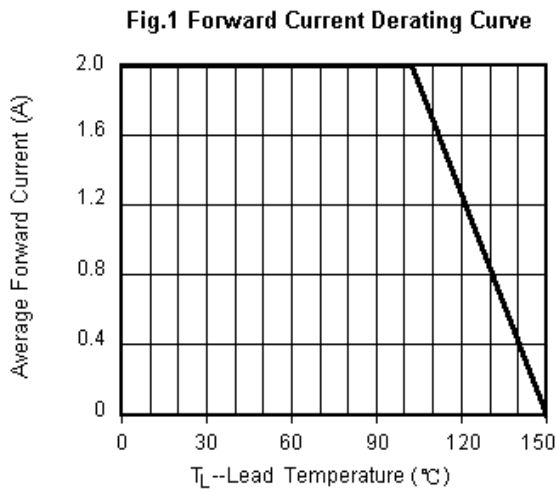
Note 2: Pulse test: 300μs pulse width, 1% duty cycle.



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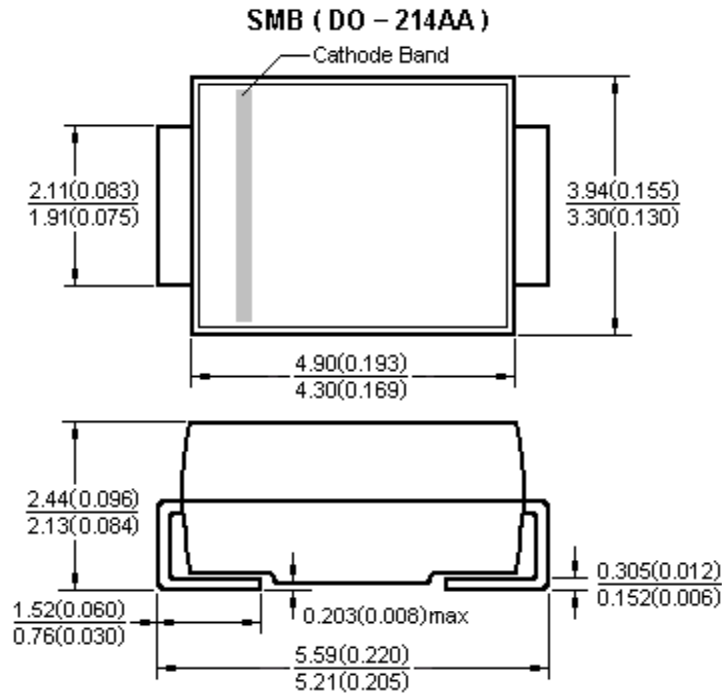
## Surface Mount Ultra Fast Rectifiers

Characteristic Curves ( $T_A=25^\circ\text{C}$  unless otherwise noted)





### Package Outline



Dimensions in millimeters and (inches)

### Notice

- Product is intended for use in general electronics applications.
- Product should be worked less than the ratings; if exceeded, may cause permanent damage. or introduce latent failure mechanisms.
- The absolute maximum ratings are rated values and must not be exceeded during operation. The following are the general derating methods you design a circuit with a device.

$I_{F(AV)}$  : We recommend that the worst case current be no greater than 80% .

$I_{FSM}$  : This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which the general during the lifespan of the device.

$T_J$  : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a  $T_J$  of below 125°C.

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